COST-EFFECTIVE & **DUAL WIPE SOCKETS** 8 Gbps

(2.00 mm) .0787" PITCH • TLE/CLT SERIES

TLE

Mates: ТММН, ТММ, МТММ, MMT, TW, LTMM, ZLTMM, TCMD, TSH

CLT Mates: ТММ, ТММН, МТММ, MMT, TW, TSH

SPECIFICATIONS

TLE Insulator Material:

Black Liquid Crystal Polymer Contact Material: Phosphor Bronze Plating: Au over 50 μ" (1.27 μm) Ni Current Rating (TLE/TMMH): 3.2 A per pin (2 pins powered) Operating Temp Range: -55 °C to +125 °C Insertion Depth: (2.08 mm) .082" to (4.37 mm) .172" with (0.38 mm) .015" wipe, pass-through, or (3.35 mm) .132" min for bottom entry CLT Same as TLE except: Plating: Sn or Au over 50 μ⁺⁺ (1.27 μm) Ni Current Rating (TMMH/CLT): 4.1 A per pin (2 pins powered) Insertion Depth: Top Entry= (1.40 mm) .055" minimum Bottom Entry= (2.57 mm) .101" minimum (add board thickness for correct post OAL) Max Cycles: 100 with 10 μ" (0.25 μm) Au

PROCESSING

TLE Lead-Free Solderable:

Yes SMT Lead Coplanarity:

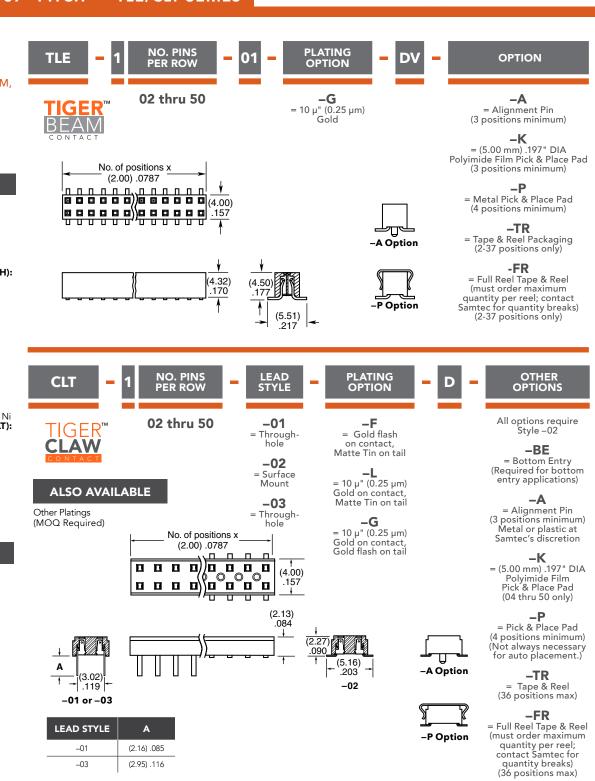
(0.10 mm) .004" max (02-26) (0.15 mm) .006" max (27-50)* *(.004" stencil solution may be available; contact ipg@samtec.com)

ĊLT

CLI Same as TLE except: SMT Lead Coplanarity: (0.10 mm) .004" max (02-25) (0.15 mm) .006" max (26-34)* (0.20 mm) .008" max (35-50)* *(.004" stencil solution may be available; contact ipg@samtec.com)

Note:

Some lengths, styles and options are non-standard, non-returnable



Unless otherwise approved in writing by Samtec, all parts and components are designed and built according to Samtec's specifications which are subject to change without notice.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Samtec: TLE-115-01-G-DV-A